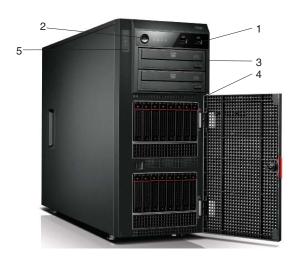
ThinkServer TD340 Overview



Front view

- 1. Front I/O: 2 USB 2.0
- Power Button 2.
- 3. Two 5.25" optical drive bays4. 16 x 2.5" hot-swap drive bays (on selected models, also supports one of the following: 4 x 3.5" direct cable bays, or 4 x 3.5" hot-swap bays, or 8 x 3.5" hot-swap bays, or 8 x 2.5" hot-swap bays)
- 5. Intelligent Diagnostics Module (optional)



Rear view

- Hot-swap power supplies, 800W, 80 PLUS Gold (on selected models, also supports one fixed power supply, 625W, 80 PLUS Bronze)
 Rear I/O: 4 USB 2.0
- - 1 Serial (9-pin) 2 RJ-45 (one for dedicate/share management)
 - 1 VGA
- 8. Expansion slots*:
 - 1 PCle 3.0 x8 (near rear I/O, 2nd CPU is needed)

 - 1 PCle 3.0 x16 1 PCle 3.0 x8 (2nd CPU is needed) 1 PCle 3.0 x8 (2nd CPU is needed) 1 PCle 3.0 x8 (x4 elec)
 - 1 PCI
 - * Add-on ethernet adapter, RAID adapter, and graphics adapter are optional

Internal

- Two LGA1356 sockets, supports up to two processors from Intel Xeon E5-2400 v2 and E5-2400 families 12 DIMM sockets, supports up to 192GB ECC LV RDIMM or 48GB ECC LV UDIMM memory Up to 16 x 2.5" hard drive bays

Mechanical

- Tower, business black color, metal case
- Rack-mountable to 5U
- W x H (without foot) x D = 7.68"/195mm x 16.9"/430mm x 23.4"/595mm
- 57.32 lb (26kg) max configuration

ThinkServer TD340 Platform Systems Specifications - I of II

Components	Specifications										
Mechanical	 Tower, rack-mountable to 5U via optional conversion kit 7.68" W x 23.4" D x 16.9" H (without foot) 195mm W x 595mm D x 430mm H (without foot) 57.3 lb (26kg) max configuration 										
Chipset	Intel C606 Chips		iidiloii								
-	Two LGA1356 sockets, supports up to two processors from Intel Xeon E5-2400 v2 or Xeon E5-2400 families, the following processor options are supported:										
	Processors Specifications*										
	Processor Numb	er # of Cores 1		Clock	Max Turbo	Caaba	QPI Speed	Max TDP	Memory Speed	Part Number	
	Intel Xeon E5-2400 v2 Series										
	Xeon E5-2470 v2	2 10	20 2.	4 GHz	3.2 GHz	25MB	8 GT/s	95W	DDR3-1600	0C19561	
	Xeon E5-2450L	v2 10	20 1.	7 GHz	2.1 GHz	25MB	7.2 GT/s	60W	DDR3-1600	0C19568	
	Xeon E5-2450 v2	2 8	16 2.	5 GHz	3.3 GHz	20MB	8 GT/s	95W	DDR3-1600	0C19562	
Dun	Xeon E5-2440 v2	2 8	16 1.	9 GHz	2.4 GHz	20MB	7.2 GT/s	95W	DDR3-1600	0C19563	
Processors	Xeon E5-2430L	v2 6	12 2.	4 GHz	2.8 GHz	15MB	7.2 GT/s	60W	DDR3-1600	0C19569	
	Xeon E5-2430 v2	2 6	12 2.	5 GHz	3 GHz	15MB	7.2 GT/s	80W	DDR3-1600	0C19564	
	Xeon E5-2420 v2	2 6	12 2.	2 GHz	2.7 GHz	15MB	7.2 GT/s	80W	DDR3-1600	0C19565	
	Xeon E5-2407 v2	2 4			2.4 GHz	10MB	6.4 GT/s	80W	DDR3-1333	0C19566	
	Xeon E5-2403 v2	2 4	4 1.	8 GHz	1.8 GHz	10MB	6.4 GT/s	80W	DDR3-1333		
	Intel Xeon E5-24	400 Series									
	Xeon E5-2420	6	12 1.	9 GHz	2.4 GHz	15MB	7.2 GT/s	95 W	DDR3-1333	0A89456	
Memory type Memory DIMMs	Notes: All processors spec The information her Intel may update thi 1600MHz, LV UD	ein is provid <u>s informatio</u> IMM or LV	ed "as-is". <u>n in non-sch</u> RDIMM, D	eduled. Fo	o <u>r latest info</u> channel pe	ormation, p	olease see <u>l</u>	nttp://ark.inte	l.com/		
Memory capacity	Twelve DIMM sockets, six DIMM sockets per processor Up to 192GB DDR3 LV RDIMM (16GB x 12) or up to 48GB DDR3 LV UDIMM (4GB x 12)										
Memory protection	ECC, memory mirroring, memory sparing										
Additional memory disclaimers	 Actual memory operating speed depends on processor memory controller speed, installed memory speed, and quantity of memory DIMMs Maximum memory operating speed are 1333MT/s on LV UDIMM models Over six DIMMs requires dual processors Mixing of LV UDIMM or LV RDIMM is not supported 										
Disk bays configurations	Supports one of the following disk bay configurations: 4 x 3.5" non-hot swap disk bays, supports SATA non-hot swap hard drives 4 x 3.5" hot-swap Disk bays, supports SATA/SAS hot-swap hard drives or SSD drives 8 x 3.5" hot-swap Disk bays, supports SATA/SAS hot-swap hard drives or SSD drives 8 x 2.5" hot-swap Disk bays, supports SATA/SAS hot-swap hard drives or SSD drives 16 x 2.5" hot-swap Disk bays, supports SATA/SAS hot-swap hard drives or SSD drives										
	RAID adapter	Disk type	RAID support*	Cache	Transfer rates	,	Optional up				
	RAID 100 (onboard)	SATA	0, 1, 10		6Gb/s	optional add RA	l upgrade k ID 5 suppc	key, ort			
	RAID 300 (onboard)	SATA/SAS	0, 1, 10		6Ch/o	optional	upgrade k ID 5 suppo	œy,			
			0, 1, 10		6Gb/s	optional add RA	upgrade k ID 5, 50 su	key, ipport			
RAID support	DAID FOO	SATA/SAS	0, 1, 10								
RAID support	RAID 500 (LSI 9240-8i)	SATA/SAS	0. 1. 10.	512MB	6Gb/s	optional	intelligent Unit (iBBL				
RAID support	RAID 500 (LSI 9240-8i) RAID 700 (LSI 9260-8i)		0, 1, 10, 5, 50, 6, 60	512MB	6Gb/s	optional Backup optional flash consuper of super of optional	Unit (iBBL al CacheVa ache with capacitor	J08) ault (CV) ade Pro 2.0)		
RAID support	RAID 500 (LSI 9240-8i) RAID 700 (LSI 9260-8i) RAID 710 (LSI 9270CV-8i)	SATA/SAS	0, 1, 10, 5, 50, 6, 60 0, 1, 10, 5, 50, 6, 60	1GB	6Gb/s	optional Backup optional flash countries super countries optional	Unit (iBBL al CacheVa ache with capacitor al CacheCa al FastPath	J08) ault (CV) ade Pro 2.0)		
RAID support Optical drive (optional)	RAID 500 (LSI 9240-8i) RAID 700 (LSI 9260-8i) RAID 710 (LSI 9270CV-8i)	SATA/SAS	0, 1, 10, 5, 50, 6, 60 0, 1, 10, 5, 50, 6, 60	1GB	6Gb/s	optional Backup optional flash consuper of the optional	Unit (iBBL al CacheVa ache with capacitor al CacheCa al FastPath drives only	J08) ault (CV) ade Pro 2.0)		

ThinkServer TD340 Platform Systems Specifications - II of II

Components	Specifications									
Front ports	Two USB 2.0									
Rear ports	Four USB 2.0, one serie	al (9-pin), two ethernet (RJ-45, o	ne for dedicate/share mgmt), one a	nalog VGA DB-15 connector						
Internal USB	One internal USB port (Type A)									
Expansion Slots	Slot 1: half-length, full-h Slot 2: half-length, full-h Slot 3: half-length, full-h Slot 4: half-length, full-h Slot 5: half-length, full-h	eight, PCIe 3.0 x8 (x4 elec) eight, PCIe 3.0 x8 eight, PCIe 3.0 x8 eight, PCIe 3.0 x8 eight, PCIe 3.0 x16 eight, PCIe 3.0 x8 (near CPU) 300 graphics/management processor, one VGA DB-15 on rear (Maximum resolution: 1600x1200@60Hz). 00 graphics adapter is available on selected models								
Graphics	Onboard Aspeed AST2	300 graphics/management proc		ximum resolution: 1600x1200@60Hz).						
Intelligent Diagnostics Module (optional) Systems management (TMM Premium is optional)	Supports optional Intelligent Diagnostics Module (IDM) on selected models, IDM LED lights indicate failing component category Onboard Aspeed AST2300 graphics/management processor, IPMI 2.0-compliant baseboard management controller (BMC); optional ThinkServer Management Module Premium for iKVM functions Front control panel LEDs shows the status of power, hard drive activity, network, system ThinkServer EasyStartup/EasyManage/EasyUpdate									
Security features (TPM is optional)	Power-on password/adi	ninistrator password/ e (TCG 1.2-compliant, optional)								
Power supply	Supports one of the foll One fixed 625 watts, the Up to two redundant & redundant with two poors.	sted Platform Module (TCG 1.2-compliant, optional) pports one of the follwing, depending on models: One fixed 625 watts, universal, 80 PLUS Bronze qualified one to two redundant 800 watts, two maximum, rear access, hot-swap, 80 PLUS Gold qualified, edundant with two power supplies								
	 Environmental certifications Energy Star Server 2.0 qualified for models with 800 watts hot-swap PSU Energy Star Server 1.1 qualified for models with 625 watts fixed PSU RoHS-compliant 									
	EMC	MC FCC Class A, CSA, CE								
	240VA	Supports								
	Temperature - operating	50 °F to 95 °F (10 °C to 35 °C)								
	Temperature - non operating (no package)	-10 °C to 60 °C								
	Temperature - non operating (with package)	-40 °C to 60 °C								
	Altitude - operating	Supported Altitude (unpressuri	zed): 0-10000ft (0-3048m)							
	Humidity - operating	10%~80%, non-condensing								
Safety, environment, and certifications	Humidity - non operating (no package)	8%~90%, non-condensing								
	Humidity - non operating (with package)	8%~90%, non-condensing								
			System	Configuration						
		Category	Entry level	High-end						
		CPU	1 x CPU	2 x CPU						
	Acoustic noise (idle/working mode)	Optical Drive	1 DVD-ROM	1 DVD-ROM						
		Drive Bays	4 x 3.5" direct cable	8 x 3.5" hot-swap						
		HDD	2 x 500GB 3.5" SATA	8 x 2TB 3.5" SAS						
		Memory	2GB x 1 (LV UDIMM)	8GB x 12 (LV RDIMM)						
	(iale/working mode)	PSU	1 x 625 watts fixed	1 x 800 watts hot-swap						
		RAID	RAID 1	RAID 5						
		Expansion Adapters	No No	1 x RAID 700 2 x Ethernet Adapters						
		Sound Pressure (operating)	37.0 dB(A)	42.0 dB(A)						
		Sound Pressure (idle)	35.0 dB(A)	38.0 dB(A)						
		Countri 1033ure (luie)	00.0 db(A)	00.0 dD(A)						